

SLVS338Q -MAY 2001-REVISED JANUARY 2014

50 mA, 24 V, 3.2-μA Supply Current Low-Dropout Linear Regulator in SC70 Package

FEATURES

- 24-V Maximum Input Voltage
- Low 3.2-µA Quiescent Current at 50 mA
- Stable With Any Capacitor (≥ 0.47 µF)
- 50-mA Low-Dropout Regulator
- Available in 1.8 V, 1.9 V, 2.3 V, 2.5 V, 3.0 V, 3.3 V, 3.45 V, 5.0 V, and Adjustable (1.2 V to 15 V)
- Designed to Support MSP430 Families:
 - 1.9-V version ensured to be higher than minimum V_{IN} of 1.8 V
 - 2.3-V version ensured to meet 2.2-V minimum V_{IN} for FLASH on MSP430F2xx
 - 3.45-V version ensured to be lower than maximum V_{IN} of 3.6 V
 - Wide variety of fixed output voltage options to match V_{IN} to the minimum required for desired MSP430 speed
- Minimum/Maximum Specified Current Limit
- 5-Pin SC70 (DCK) and 6-Pin SON (DSE) Packages
- -40°C to +125°C Specified Junction Temperature Range
- For 80-mA Rated Current and Higher Power Package, see TPS715Axx

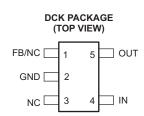
APPLICATIONS

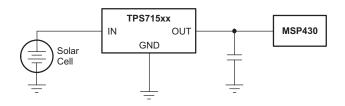
- Ultra-Low Power Microcontrollers
- Cellular/Cordless Handsets
- Portable/Battery-Powered Equipment

DESCRIPTION

The TPS715xx low-dropout (LDO) voltage regulators offer the benefits of high input voltage, low-dropout voltage, low-power operation, and miniaturized packaging. The devices, which operate over an input range of 2.5 V to 24 V, are stable with any capacitor (≥ 0.47 µF). The low dropout voltage and low quiescent current allow operations at extremely low power levels. Therefore, the devices are ideal for powering battery management ICs. Specifically, since the devices are enabled as soon as the applied voltage reaches the minimum input voltage, the output is quickly available to power continuously operating battery charging ICs.

The usual PNP pass transistor has been replaced by a PMOS pass element. Because the PMOS pass element behaves as a low-value resistor, the low dropout voltage, typically 415 mV at 50 mA of load current, is directly proportional to the load current. The low quiescent current (3.2 μ A typically) is stable over the entire range of output load current (0 mA to 50 mA).





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION(1)

PRODUCT	V _{OUT} ⁽²⁾
TPS715 xx <i>yyy z</i>	XX is nominal output voltage (for example, 28 = 2.8 V, 285 = 2.85 V, 01 = Adjustable). YYY is package designator. Z is package quantity.

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www ti com.
- (2) Output voltages from 1.25 V to 5.4 V in 50-mV increments are available through the use of innovative factory EEPROM programming; minimum order quantities may apply. Contact factory for details and availability.

ABSOLUTE MAXIMUM RATINGS(1) (2)

Over operating temperature range (unless otherwise noted).

	UNIT
V _{IN} range	-0.3 V to +24 V
V _{OUT} range	–0.3 V to +16.5 V
Peak output current	Internally limited
ESD rating, HBM	2 kV
ESD rating, CDM	500 V
Continuous total power dissipation	See Dissipation Rating Table
Junction temperature range, T _J	-40°C to +150°C
Storage temperature range, T _{stg}	−65°C to +150°C

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE

BOARD	PACKAGE	R _{θJC} °C/W	R _{θJA} °C/W	DERATING FACTOR ABOVE T _A = +25°C	T _A ≤ 25°C POWER RATING	T _A = +70°C POWER RATING	T _A = +85°C POWER RATING	
Low-K ⁽¹⁾	DCK	165	395	2.52 mW/°C	250 mW	140 mW	100 mW	
High-K ⁽²⁾	DCK	165	315	3.18 mW/°C	320 mW	175 mW	130 mW	

- (1) The JEDEC Low-K (1s) board design used to derive this data was a 3 inch x 3 inch, two-layer board with 2 ounce copper traces on top of the board.
- (2) The JEDEC High-K (2s2p) board design used to derive this data was a 3 inch x 3 inch, multilayer board with 1 ounce internal power and ground planes and 2 ounce copper traces on top and bottom of the board.



ELECTRICAL CHARACTERISTICS

Over operating junction temperature range (T_J = -40° C to $+125^{\circ}$ C), $V_{IN} = V_{OUT(NOM)} + 1$ V, $I_{OUT} = 1$ mA, and $C_{OUT} = 1$ μ F, unless otherwise noted. Typical values are at $T_{J} = +25^{\circ}$ C.

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Input voltage ⁽¹⁾ V _{IN}			I _O = 10 mA	2.5		24		
input voitage\"		V _{IN}	I _O = 50 mA	3		24	V	
V _{OUT} voltage rang	e (TPS71501)			1.2		15	V	
V(1)	0	a.a.d T	V _{OUT} + 1.0 V ≤ V _{IN} ≤ 24 V	4.0		. 4.0	0/	
V _{OUT} accuracy ⁽¹⁾	Over V _{IN} , I _{OL}	_{JT} , and I	100 μA ≤ I _{OUT} ≤ 50 mA	-4.0		+4.0	%	
			$0 \le I_{OUT} \le 50 \text{ mA}, T_{J} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$		3.2	4.2		
Ground pin current ⁽²⁾		I _{GND}	0 mA ≤ I _{OUT} ≤ 50 mA		3.2	4.8	μΑ	
			$0 \text{ mA} \le I_{OUT} \le 50 \text{ mA}, V_{IN} = 24 \text{ V}$			5.8		
Load regulation	ΔV _{OUT} /ΔI _{OUT}	-	I _{OUT} = 100 μA to 50 mA		22		mV	
Output voltage line regulation (1)	$\Delta V_{OUT}/\Delta V_{IN}$		V _{OUT} + 1 V < V _{IN} ≤ 24 V		20	60	mV	
Output noise volta	ge	V _n	BW = 200 Hz to 100 kHz, C_{OUT} = 10 μ F, I_{OUT} = 50 mA		575		μVrms	
Output summent line	:.		$V_{OUT} = 0 \text{ V}, V_{IN} \ge 3.5 \text{ V}$	125		750	mA	
Output current lim	Ιτ	I _{CL}	V _{OUT} = 0 V, V _{IN} < 3.5 V	90		5.8	mA	
Power-supply ripp	le rejection	PSRR	f = 100 kHz, C _{OUT} = 10 μF		60		dB	
Dropout voltage V _{IN} = V _{OUT(NOM)} -	0.1 V	V _{DO}	I _{OUT} = 50 mA		415	750	mV	

 ⁽¹⁾ Minimum V_{IN} = V_{OUT} + V_{DO} or the value shown for *Input voltage* in this table, whichever is greater.
 (2) See Figure 1. The TPS715xx family employs a leakage null control circuit. This circuit is active only if output current is less than pass FET leakage current. The circuit is typically active when output load is less than 5 μA, V_{IN} is greater than 18 V, and die temperature is greater than +100°C.



FUNCTIONAL BLOCK DIAGRAMS

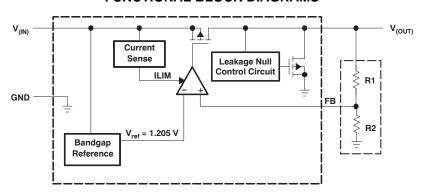


Figure 1. Functional Block Diagram—Adjustable Version

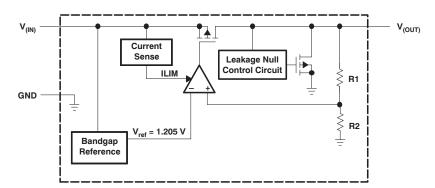


Figure 2. Functional Block Diagram—Fixed Version

PIN CONFIGURATION

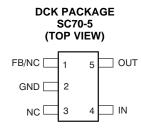


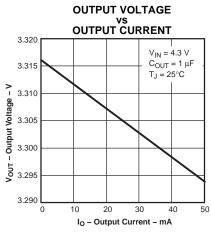
Table 1. Terminal Functions

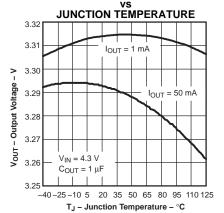
	TERMINAL						
NAME	N	0.	DESCRIPTION				
INAIVIE	FIXED	ADJ.					
FB	_ 1 /		Adjustable version only. This terminal is used to set the output voltage.				
NC	1 —		No connection				
GND	2	2	Ground				
NC	3	3	No connection				
IN	4	4	Input supply.				
OUT	5	5	Output of the regulator, any output capacitor ≥ 0.47 µF can be used for stability.				



TYPICAL CHARACTERISTICS

OUTPUT VOLTAGE





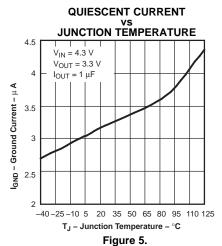
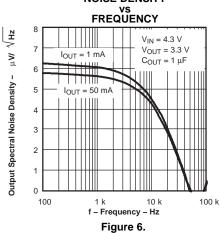


Figure 3.

OUTPUT SPECTRAL NOISE DENSITY



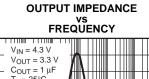
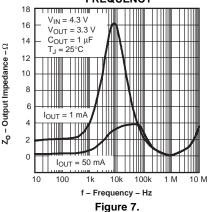
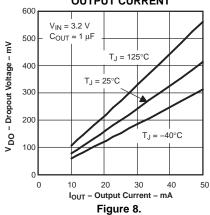


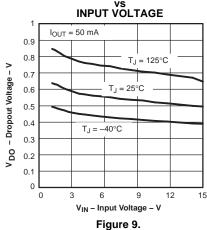
Figure 4.

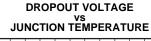


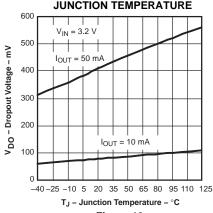
DROPOUT VOLTAGE vs OUTPUT CURRENT



TPS71501 DROPOUT VOLTAGE







POWER-SUPPLY RIPPLE REJECTION vs FREQUENCY

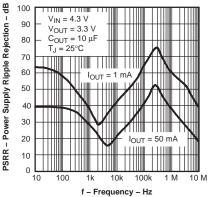
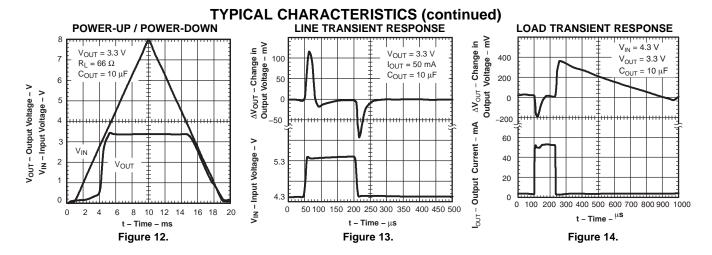


Figure 10.

Figure 11.







APPLICATION INFORMATION

The TPS715xx family of LDO regulators has been optimized for ultra-low power applications such as the MSP430 microcontroller. Its ultra-low supply current maximizes efficiency at light loads, and its high input voltage range makes it suitable for supplies such as unconditioned solar panels.

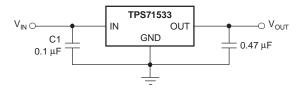


Figure 15. Typical Application Circuit (Fixed Voltage Version)

External Capacitor Requirements

Although not required, a 0.047-µF or larger input bypass capacitor, connected between IN and GND and located close to the device, is recommended to improve transient response and noise rejection of the power supply as a whole. A higher-value input capacitor may be necessary if large, fast-rise-time load transients are anticipated and the device is located several inches from the power source.

The TPS715xx requires an output capacitor connected between OUT and GND to stabilize the internal control loop. Any capacitor (including ceramic and tantalum) greater than or equal to $0.47~\mu F$ properly stabilizes this loop. X7R type capacitors are recommended, but X5R and others may be used.

Power Dissipation and Junction Temperature

To ensure reliable operation, worst-case junction temperature should not exceed +125°C. This restriction limits the power dissipation the regulator can handle in any given application. To ensure the junction temperature is within acceptable limits, calculate the maximum allowable dissipation, $P_{D(max)}$, and the actual dissipation, P_D , which must be less than or equal to $P_{D(max)}$.

The maximum-power-dissipation limit is determined using the following equation:

$$P_{D(max)} = \frac{T_{J}^{max} - T_{A}}{R_{\theta JA}}$$
(1)

where:

- T₁max is the maximum allowable junction temperature.
- R_{A,IA} is the thermal resistance junction-to-ambient for the package (see the Dissipation Ratings table).
- T_A is the ambient temperature.

The regulator dissipation is calculated using:

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{OUT}$$
(2)

For a higher power package version of the TPS715xx, see the TPS715Axx.

Regulator Protection

The TPS715xx PMOS-pass transistor has a built-in back diode that conducts reverse current when the input voltage drops below the output voltage (e.g., during power-down). Current is conducted from the output to the input and is not internally limited. If extended reverse voltage operation is anticipated, external limiting might be appropriate.

The TPS715xx features internal current limiting. During normal operation, the TPS715xx limits output current to approximately 500 mA. When current limiting engages, the output voltage scales back linearly until the overcurrent condition ends. Take care not to exceed the power dissipation ratings of the package.



Programming the TPS71501 Adjustable LDO Regulator

The output voltage of the TPS71501 adjustable regulator is programmed using an external resistor divider as shown in Figure 16. The output voltage operating range is 1.2 V to 15 V, and is calculated using:

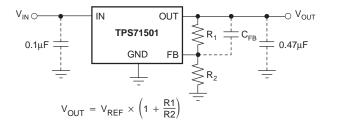
$$V_{OUT} = V_{REF} \times \left(1 + \frac{R1}{R2}\right) \tag{3}$$

where:

• $V_{RFF} = 1.205 \text{ V typ}$ (the internal reference voltage)

Resistors R1 and R2 should be chosen for approximately 1.5- μ A divider current. Lower value resistors can be used for improved noise performance, but the solution consumes more power. Higher resistor values should be avoided as leakage current into/out of FB across R1/R2 creates an offset voltage that artificially increases/decreases the feedback voltage and thus erroneously decreases/increases V_{OUT} . The recommended design procedure is to choose R2 = 1 M Ω to set the divider current at 1.5 μ A, and then calculate R1 using Equation 4:

$$R1 = \left(\frac{V_{OUT}}{V_{REF}} - 1\right) \times R2 \tag{4}$$



OUTPUT VOLTAGE PROGRAMMING GUIDE

OUTPUT VOLTAGE	R1	R2
1.8 V	0.499 MΩ	1 ΜΩ
2.8 V	1.33 MΩ	1 ΜΩ
5.0 V	3.16 MΩ	1 ΜΩ

Figure 16. TPS71501 Adjustable LDO Regulator Programming

Power the MSP430 Microcontroller

Several versions of the TPS715xx are ideal for powering the MSP430 microcontroller. Table 2 shows potential applications of some voltage versions.

Table 2. Typical MSP430 Applications

DEVICE	V _{OUT} (TYP)	APPLICATION
TPS71519	1.9 V	V _{OUT, MIN} > 1.800 V required by many MSP430s. Allows lowest power consumption operation.
TPS71523	2.3 V	V _{OUT, MIN} > 2.200 V required by some MSP430s FLASH operation.
TPS71530	3.0 V	V _{OUT, MIN} > 2.700 V required by some MSP430s FLASH operation.
TPS715345	3.45 V	V _{OUT, MIN} < 3.600 V required by some MSP430s. Allows highest speed operation.

The TPS715xx family offers many output voltage versions to allow designers to minimize the supply voltage for the processing speed required of the MSP430. This minimizes the supply current consumed by the MSP430.

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REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Cł	hanges from Revision P (November 2008) to Revision Q	Pag	јe
•	Changed test condition for V _{OUT} accuracy parameter		3





31-Oct-2013

PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
BQ71533DCKR	OBSOLETE	SC70	DCK	5		TBD	Call TI	Call TI	-40 to 85	AQI	
BQ71533DCKRG4	OBSOLETE	SC70	DCK	5		TBD	Call TI	Call TI	-40 to 85		
TPS71501DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		ARB	Samples
TPS71501DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		ARB	Samples
TPS71518DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARD	Samples
TPS71518DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARD	Samples
TPS71519DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	BOX	Samples
TPS71519DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	BOX	Samples
TPS71523DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	BNX	Samples
TPS71523DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	BNX	Samples
TPS71525DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AQL	Samples
TPS71525DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AQL	Samples
TPS71530DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AQM	Samples
TPS71530DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AQM	Samples
TPS71533DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AQI	Samples
TPS71533DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AQI	Samples
TPS715345DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	BNY	Samples
TPS715345DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	BNY	Samples



PACKAGE OPTION ADDENDUM

31-Oct-2013

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TPS71550DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	T48	Samples
TPS71550DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	T48	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.





31-Oct-2013

OTHER QUALIFIED VERSIONS OF TPS71501, TPS71525, TPS71530, TPS71533, TPS71550:

Automotive: TPS71501-Q1, TPS71525-Q1, TPS71530-Q1, TPS71533-Q1, TPS71550-Q1

● Enhanced Product: TPS71501-EP

NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

• Enhanced Product - Supports Defense, Aerospace and Medical Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 12-Aug-2013

TAPE AND REEL INFORMATION



TAPE DIMENSIONS KO P1 BO W Cavity AO

	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS71501DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71501DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71518DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71519DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71523DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71523DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71525DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71525DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71530DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71530DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS71533DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71533DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS715345DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71550DCKR	SC70	DCK	5	3000	180.0	8.4	2.25	2.4	1.22	4.0	8.0	Q3
TPS71550DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS71501DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71501DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71518DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71519DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71523DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71523DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71525DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71525DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71530DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71530DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS71533DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71533DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS715345DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71550DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TPS71550DCKR	SC70	DCK	5	3000	180.0	180.0	18.0

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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